

# MCP120/130

# Microcontroller Supervisory Circuit with Open Drain Output

# FEATURES

- Holds microcontroller in reset until supply voltage reaches stable operating level
- · Resets microcontroller during power loss
- Precision monitoring of 3V, 3.3V and 5V systems
- 7 voltage trip points available
- Active low RESET pin
- Open drain output
- Internal pull-up resistor (5 kΩ) for MCP130
- Holds RESET for 350 ms (typical)
- RESET to Vcc = 1.0V
- Accuracy of ±125 mV for 5V systems and ±75 mV for 3V systems over temperature
- 45 μA typical operating current
- Temperature range:
  - Industrial (I): -40°C to +85°C

# DESCRIPTION

The Microchip Technology Inc. MCP120/130 is a voltage supervisory device designed to keep a microcontroller in reset until the system voltage has reached the proper level and stabilized. It also operates as protection from brown-out conditions when the supply voltage drops below a safe operating level. Both devices are available with a choice of seven different trip voltages and both have open drain outputs. The MCP130 has an internal 5 k $\Omega$  pullup resistor. Both devices have active low RESET pins. The MCP120/130 will assert the RESET signal whenever the voltage on the VDD pin is below the trip-point voltage.

# PACKAGES



# **BLOCK DIAGRAM**



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# 1.0 ELECTRICAL CHARACTERISTICS

# 1.1 Maximum Ratings\*

# DC AND AC CHARACTERISTICS

\*Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

| All parameters apply at the specified temp and voltage ranges unless otherwise noted. |  | VDD = 1.0 -<br>Industrial (I | 5.5V<br>): -40°C to ·                               | +85°C   |  |       |   |  |
|---|--|------------------------------|---|---|--|-------|---|--|
| Parameter   |  | Symbol                       | Min.  | Тур.  | Max.   | Units | Test Conditions   |  |
| Operating Voltag  | ge Range   | Vdd                          | 1.0   | _   | 5.5  | V     |   |  |
| VDD Value to RE   | SET  | Vdd <sub>min</sub>           | 1.0   | _   |  | V     |   |  |
| Operating Curre   | ent  | ldd                          | —   | 45  | 60   | μA    | VDD = 5.5V (no load)  |  |
| VDD Trip Point  | MCP1X0-270<br>MCP1X0-300<br>MCP1X0-315<br>MCP1X0-450<br>MCP1X0-460<br>MCP1X0-475<br>MCP1X0-485 | VTRIP                        | 2.55<br>2.85<br>3.0<br>4.25<br>4.35<br>4.50<br>4.60 | 2.625<br>2.925<br>3.075<br>4.375<br>4.475<br>4.625<br>4.725 | 2.7<br>3.0<br>3.15<br>4.50<br>4.60<br>4.75<br>4.85 | V     |   |  |
| RESET Low<br>Level Output<br>Voltage  | MCP1X0-270<br>MCP1X0-300<br>MCP1X0-315   | Vol                          |   | _   | 0.4  | V     | IOL = 3.2 mA,<br>VDD = VTRIP <sub>MIN</sub>   |  |
|   | MCP1X0-450<br>MCP1X0-460<br>MCP1X0-475<br>MCP1X0-485   |                              | _   |   | 0.6  |       | IOL = 8.5 mA,<br>VDD = VTRIP <sub>MIN</sub>   |  |
| RESET High<br>Level Output<br>Voltage<br>(MCP130 Only)                                | MCP130-xxx<br>(All VTRIP<br>Points)  | Vон                          | Vdd-0.7   | _   | _  | V     | Ioh = 50 $\mu$ A,Vdd > Vtrip <sub>max</sub>   |  |
| Pull-up Resistor  | (MCP130 Only)  |                              | —   | 5   | _  | kΩ    |   |  |
| Output Leakage  | Output Leakage (MCP120 Only)   |                              | —   | 1   | _  | μΑ    |   |  |
| Threshold Hyste   | Threshold Hysteresis   |                              | _   | 50  | _  | mV    |   |  |
| VDD Detect to R   | ESET Inactive  | tRPU                         | 150   | 350   | 700  | ms    |   |  |
| VDD Detect to RESET   |  | tRPD                         | —   | 10  |  | μs    | VDD ramped from VTRIP <sub>MAX +</sub><br>250 mV down to VTRIP <sub>MIN</sub> -<br>250 mV |  |
| <b>Note:</b> Typical values are for 25°C and VDD = 5.0V                               |  |                              |   |   |  |       |   |  |



Figure 1-1: MCP120/130 Timing Diagram

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# 2.0 APPLICATIONS INFORMATION

# 2.1 The Need for Supervisory Circuits

For many of today's microcontroller applications, care must be taken to prevent low power conditions that can cause many different system problems. The most common causes are brown-out conditions where the system supply drops below the operating level momentarily, and the second, is when a slowly decaying power supply causes the microcontroller to begin executing instructions without enough voltage to sustain SRAM and producing indeterminate results.



Figure 2-1: Typical Application

# 2.2 Negative Going VDD Transients

Many system designers implementing POR circuits are concerned about the minimum pulse width required to cause a reset. Figure 2-2 shows typical transient voltage below the trip point (VTRIP - VDD) vs. transient duration. It shows that the farther below the trip point the transient pulse goes, the duration of the pulse required to cause a reset gets shorter. A 0.1  $\mu$ F bypass cap mounted as close as possible to the VDD pin provides additional transient immunity.



Figure 2-2: Typical Transient Response

#### 2.3 Effect of Temperature on Timeout Period (tRPU)

The timeout period (tRPU) determines how long the device remains in the reset condition. This is controlled by an internal RC timer and is effected by both VDD and temperature. The graph shown in Figure 2-3 shows typical response for different VDD values and temperatures.



Figure 2-3: tRPU vs. Temperature



Figure 2-4: IDD vs. Temperature



Figure 2-5: Normalized VTRIP vs. Temperature







Figure 2-7: Normalized IOL vs. Temperature

# 3.0 PACKAGING INFORMATION

# 3.1 Package Marking Information

3-Lead Plastic Transistor Outline (TO-92)



8-Lead Plastic Small Outline (SOIC)



3-Lead Plastic Small Outline Transistor (SOT23)





Example:



Example:



# SOT23 PARTS LABELING:

The table below identifies the first 2 characters (XX) in the 4-character field (XXNN) for marking of the 3-Lead SOT23 package.

| Mark | Part Number     | Mark | Part Number     |
|------|-----------------|------|-----------------|
| SJ   | MCP120T-270I/TT | PJ   | MCP130T-270I/TT |
| SK   | MCP120T-300I/TT | PK   | MCP130T-300I/TT |
| SL   | MCP120T-315I/TT | PL   | MCP130T-315I/TT |
| SM   | MCP120T-450I/TT | PM   | MCP130T-450I/TT |
| SN   | MCP120T-460I/TT | PN   | MCP130T-460I/TT |
| SO   | MCP120T-475I/TT | PO   | MCP130T-475I/TT |
| SP   | MCP120T-485I/TT | PP   | MCP130T-485I/TT |

| Legend: | XXX<br>YY<br>WW<br>NNN | Customer specific information*<br>Year code (last 2 digits of calendar year)<br>Week code (week of January 1 is week '01')<br>Alphanumeric traceability code |
|---------|------------------------|--|
| Note:   | In the even            | t the full Microchip part number cannot be marked on one line, it will   |
|         | be carried of          | over to the next line thus limiting the number of available characters   |
|         | for custome            | er specific information.   |

\* Standard OTP marking consists of Microchip part number, year code, week code, and traceability code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

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#### 3.2 Package Detail Information

3-Lead Plastic Transistor Outline (TO) (TO-92)



|                         | Units  | INCHES* |      |      | MILLIMETERS |       |       |
|-------------------------|--------|---------|------|------|-------------|-------|-------|
| Dimension               | Limits | MIN     | NOM  | MAX  | MIN         | NOM   | MAX   |
| Number of Pins          | n      |         | 3    |      |             | 3     |       |
| Pitch                   | р      |         | .050 |      |             | 1.27  |       |
| Bottom to Package Flat  | Α      | .130    | .143 | .155 | 3.30        | 3.62  | 3.94  |
| Overall Width           | E1     | .175    | .186 | .195 | 4.45        | 4.71  | 4.95  |
| Overall Length          | D      | .170    | .183 | .195 | 4.32        | 4.64  | 4.95  |
| Molded Package Radius   | R      | .085    | .090 | .095 | 2.16        | 2.29  | 2.41  |
| Tip to Seating Plane    | L      | .500    | .555 | .610 | 12.70       | 14.10 | 15.49 |
| Lead Thickness          | С      | .014    | .017 | .020 | 0.36        | 0.43  | 0.51  |
| Lead Width              | В      | .016    | .019 | .022 | 0.41        | 0.48  | 0.56  |
| Mold Draft Angle Top    | α      | 4       | 5    | 6    | 4           | 5     | 6     |
| Mold Draft Angle Bottom | β      | 2       | 3    | 4    | 2           | 3     | 4     |
|                         |        |         |      |      |             |       |       |

\*Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: TO-92

Drawing No. C04-101

3-Lead Plastic Small Outline Transistor (TT) (SOT23)











|                            | Units  | INCHES* |      |      | MILLIMETERS |      |      |
|----------------------------|--------|---------|------|------|-------------|------|------|
| Dimension                  | Limits | MIN     | NOM  | MAX  | MIN         | NOM  | MAX  |
| Number of Pins             | n      |         | 3    |      |             | 3    |      |
| Pitch                      | р      |         | .038 |      |             | 0.96 |      |
| Outside lead pitch (basic) | p1     |         | .076 |      |             | 1.92 |      |
| Overall Height             | Α      | .035    | .040 | .044 | 0.89        | 1.01 | 1.12 |
| Molded Package Thickness   | A2     | .035    | .037 | .040 | 0.88        | 0.95 | 1.02 |
| Standoff §                 | A1     | .000    | .002 | .004 | 0.01        | 0.06 | 0.10 |
| Overall Width              | E      | .083    | .093 | .104 | 2.10        | 2.37 | 2.64 |
| Molded Package Width       | E1     | .047    | .051 | .055 | 1.20        | 1.30 | 1.40 |
| Overall Length             | D      | .110    | .115 | .120 | 2.80        | 2.92 | 3.04 |
| Foot Length                | L      | .014    | .018 | .022 | 0.35        | 0.45 | 0.55 |
| Foot Angle                 | φ      | 0       | 5    | 10   | 0           | 5    | 10   |
| Lead Thickness             | С      | .004    | .006 | .007 | 0.09        | 0.14 | 0.18 |
| Lead Width                 | В      | .015    | .017 | .020 | 0.37        | 0.44 | 0.51 |
| Mold Draft Angle Top       | α      | 0       | 5    | 10   | 0           | 5    | 10   |
| Mold Draft Angle Bottom    | β      | 0       | 5    | 10   | 0           | 5    | 10   |

\* Controlling Parameter § Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: TO-236 Drawing No. C04-104

# 8-Lead Plastic Small Outline (SN) - Narrow, 150 mil (SOIC









|                          | Units  | INCHES* |      |      | MILLIMETERS |      |      |
|--------------------------|--------|---------|------|------|-------------|------|------|
| Dimension                | Limits | MIN     | NOM  | MAX  | MIN         | NOM  | MAX  |
| Number of Pins           | n      |         | 8    |      |             | 8    |      |
| Pitch                    | р      |         | .050 |      |             | 1.27 |      |
| Overall Height           | А      | .053    | .061 | .069 | 1.35        | 1.55 | 1.75 |
| Molded Package Thickness | A2     | .052    | .056 | .061 | 1.32        | 1.42 | 1.55 |
| Standoff §               | A1     | .004    | .007 | .010 | 0.10        | 0.18 | 0.25 |
| Overall Width            | E      | .228    | .237 | .244 | 5.79        | 6.02 | 6.20 |
| Molded Package Width     | E1     | .146    | .154 | .157 | 3.71        | 3.91 | 3.99 |
| Overall Length           | D      | .189    | .193 | .197 | 4.80        | 4.90 | 5.00 |
| Chamfer Distance         | h      | .010    | .015 | .020 | 0.25        | 0.38 | 0.51 |
| Foot Length              | L      | .019    | .025 | .030 | 0.48        | 0.62 | 0.76 |
| Foot Angle               | φ      | 0       | 4    | 8    | 0           | 4    | 8    |
| Lead Thickness           | С      | .008    | .009 | .010 | 0.20        | 0.23 | 0.25 |
| Lead Width               | В      | .013    | .017 | .020 | 0.33        | 0.42 | 0.51 |
| Mold Draft Angle Top     | α      | 0       | 12   | 15   | 0           | 12   | 15   |
| Mold Draft Angle Bottom  | β      | 0       | 12   | 15   | 0           | 12   | 15   |

\* Controlling Parameter § Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MS-012 Drawing No. C04-057

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# MCP120/130

NOTES:

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# **PRODUCT IDENTIFICATION SYSTEM**

To order or to obtain information (e.g., on pricing or delivery), please refer to the factory or the listed sales offices.

| PART NO. X                            | ¥   | ×  | <u>/xx</u>   | Exa            | amples:  |
|---------------------------------------|---|--|--|----------------|--|
| Device RESE<br>RESE<br>VTRI<br>Voltag | T/ Bond<br>T Opti<br>ge                                     | out Temperature<br>on Range  | Package  | a)<br>b)       | MCP120–270I/SN = VTRIP range of 2.55V -<br>2.70V, Industrial Temp., SOIC package<br>MCP120–300DI/TO = VTRIP range of 2.85V -<br>3.00V, Bonding Option D, Industrial Temp.,   |
| Device:                               | MCP120:<br>MCP120T:<br>MCP130:<br>MCP130T:                  | Supervisor circuit w<br>Supervisor circuit w<br>(tape & reel)<br>Supervisor circuit wi<br>internal pull-up resis<br>Supervisor circuit wi<br>internal pull-up resis  | ith open drain output<br>ith open drain output<br>ith open drain output and<br>stor<br>ith open drain output and<br>stor (tape & reel) | c)<br>d)<br>e) | TO-92 package<br>MCP120T-315I/TT = VTRIP range of 3.00V -<br>3.15V, Industrial Temp., SOT-23 package<br>MCP130-450I/SN = VTRIP range of 4.25V -<br>4.50V, Industrial Temp., SOIC package<br>MCP130-460FI/TO = VTRIP range of 4.35V -<br>4.60V, Bonding Option F, Industrial Temp., |
| RESET/RESET VTRIP<br>Voltage          | 270 =<br>300 =<br>315 =<br>450 =<br>460 =<br>475 =<br>485 = | $\begin{array}{l} 2.55 \leq VTRIP \leq 2.70 \\ 2.85 \leq VTRIP \leq 3.00 \\ 3.00 \leq VTRIP \leq 3.15 \\ 4.25 \leq VTRIP \leq 4.50 \\ 4.35 \leq VTRIP \leq 4.60 \\ 4.50 \leq VTRIP \leq 4.75 \\ 4.60 \leq VTRIP \leq 4.85 \end{array}$ |  | f)             | TO-92 package<br>MCP130T–475I/TT = Tape & Reel, VTRIP<br>range of 4.50V - 4.75V, Industrial Temp.,<br>SOT-23 package<br>TO-92 with TO-92 with<br>'D' Bondout 'F' Bondout   |
| Bondout Option:<br>(TO-92 Only)       | D =<br>F =<br>G =<br>H =                                    | D Bond Option (see<br>F Bond Option<br>G Bond Option<br>H Bond Option  | bond option chart)   |                | RST VDD VSS VSS VDD  |
| Temperature Range:                    | I =   | -40°C to +85°C (only   | offered in I)  |                | MCP120 MCP130<br>MCP130  |
| Package:                              | SN =<br>TO =<br>TT =  | SOIC (8-lead, 150 r<br>TO-92 (3-lead) [offe<br>SOT-23 (3-lead) [of   | nil body)<br>ered in bags only]<br>fered in tape & reel only]  |                | TO-92 with TO-92 with<br>'G' Bondout 'H' Bondout   |
|                                       |   |  |  |                | VDD<br>VSS<br>RST<br>VDD<br>VSS<br>RST<br>VDD<br>VSS<br>RST<br>VSS<br>MCP120<br>MCP130   |

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Microchip Technology Korea 168-1, Youngbo Bldg. 3 Floor Samsung-Dong, Kangnam-Ku Seoul, Korea Tel: 82-2-554-7200 Fax: 82-2-558-5934 Singapore Microchip Technology Singapore Pte Ltd. 200 Middle Road #07-02 Prime Centre Singapore, 188980

Tel: 65-334-8870 Fax: 65-334-8850

Taiwan Microchip Technology Taiwan 11F-3, No. 207 Tung Hua North Road Taipei, 105, Taiwan Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

#### **EUROPE**

#### Denmark

Microchip Technology Denmark ApS **Regus Business Centre** Lautrup hoj 1-3 Ballerup DK-2750 Denmark Tel: 45 4420 9895 Fax: 45 4420 9910 France Arizona Microchip Technology SARL Parc d'Activite du Moulin de Massy 43 Rue du Saule Trapu Batiment A - ler Etage 91300 Massy, France Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79 **Germany** Arizona Microchip Technology GmbH Gustav-Heinemann Ring 125 D-81739 Munich, Germany Tel: 49-89-627-144 0 Fax: 49-89-627-144-44 Germany Analog Product Sales Lochhamer Strasse 13 D-82152 Martinsried, Germany Tel: 49-89-895650-0 Fax: 49-89-895650-22 Italy Arizona Microchip Technology SRL Centro Direzionale Colleoni Palazzo Taurus 1 V. Le Colleoni 1 20041 Agrate Brianza Milan, Italy Tel: 39-039-65791-1 Fax: 39-039-6899883 United Kingdom Arizona Microchip Technology Ltd. 505 Eskdale Road Winnersh Triangle Wokingham Berkshire, England RG41 5TU Tel: 44 118 921 5869 Fax: 44-118 921-5820

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